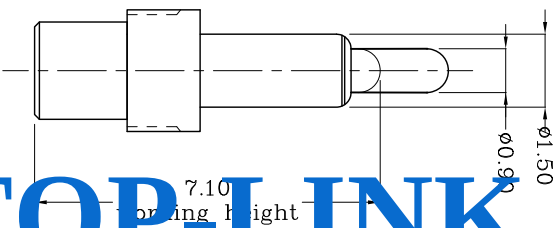
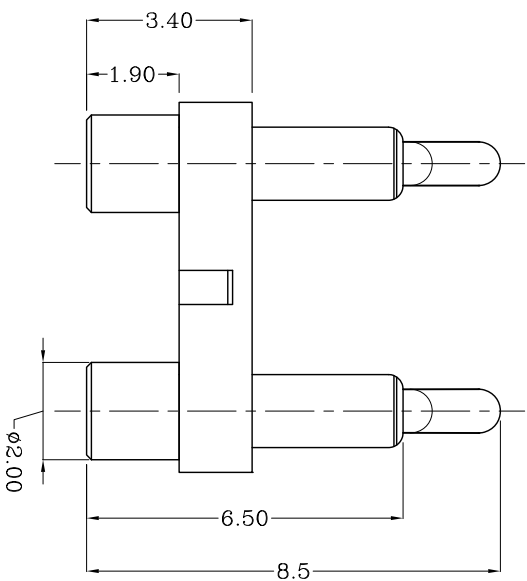
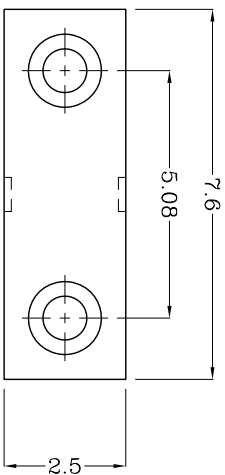
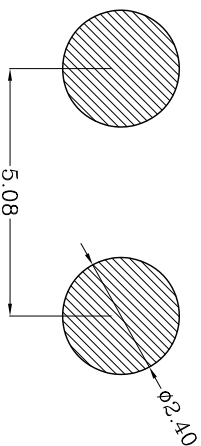


DWG NO.
C-100177



TOP-LINK



Recommended PCB Layout

Recommended solder paste thickness is 0.10 mm

Notes:
1 Material, Housing: PA 4.6 (30% Glass Filled)
Color Black (UL94V-0)
Contact: Brass
2 Mechanical demands:
Plating plunger: 0.40µm Au over 1.4µm Ni
Plating body: 0.10µm Au over 1.4µm Ni
Force is 115±35 gf at least at working height.

	Add WH		2009/09/09
LTR	REVISION RECORD	APVD	DATE

DIMENSIONS IN MM TOLERANCES UNLESS OTHER SPECIFIED		MATERIAL		HT TR		FIN	
0 = ±		DWN		APVD		—	
0.0 = ±0.15		Qln		Lansing		Top-Link	
0.00 = ±0.10		CHK		REL		Electronics	
0.000 = ±		Jlm				Electronics Ltd.	
ANGLE: ±1°							
SURF. TEXTURE: 32/		NAME BATTERY CONNECTOR 2 POS.					
REMOVED BURRS, BREAK SHARP EDGES, R0.05 MAX		PGC-1.5-8.5-R-2P-5.08PH					
DO NOT SCALE PRINT		SCALE		DWG		SHEET	
		1:1		A4		1 OF 1	
				C-100177		REV	
						B	

100177-2
PART NUMBER

USED ON

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